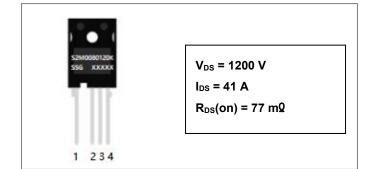
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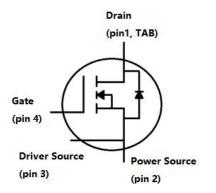
S2M0080120K

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S2M0080120K 1200V SIC POWER MOSFET



Circuit Diagram



Description

S2M0080120K is single SiC Power MOSFET packaged in TO-247-4 case. The device is a high voltage n-channel enhancement mode MOSFET that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S2M0080120K is ideal for energy sensitive, high frequency applications in challenging environments.

Features

- Positive temperature characteristics, easy to parallel.
- Low on-resistance Typ. RDS(on) = 77mQ .
- Fast switching speed and low switching losses.
- Very fast and robust intrinsic body diode.
- "-A" is an AEC-Q101 qualified device
- Process of non-bright Tin electroplatin

Applications

- EV Fast Charging Modules
- EV On Board Chargers
- Solar Inverters
- Online UPS/Industrial UPS
- SMPS (Switch Mode Power Supplies)
- DC-DC Converters
- ESS (Energy Storage Systems)

Maximum Ratings(T=25°C unless otherwise specified)

Characteristics	Symbol	Condition	Max.	Units
Drain Source Voltage	V _{DSS}	$V_{GS} = 0V, I_{DS} = 100uA, T_{C} = 25^{\circ}C$	1200	V
Gate Source Voltage	V _{GSS}	T _c = 25°C, Absolute maximum values, AC (f>1Hz)	-10 to +25	V
Gate Source Voltage	Vgsop	T _c = 25°C Recommended Operational Values	-5 to +20	V
Continuous Drain Current	Ι _D	$V_{GS} = 20V, T_{C} = 25^{\circ}C$	41	А
	ID	$V_{GS} = 20V, T_{C} = 100^{\circ}C$	29	А
Pulsed Drain Current	I _{D,pulse}	T _c =25°C	82	А
Power Dissipation	PD	Tc=25°C	231	W

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Electrical Characteristics(T=25°C unless otherwise specified)

Characteristics	Symbol	Condition	Min.	Тур.	Max.	Unit s	
Drain Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0V, I _D = 1mA	1200			V	
	$V_{\text{GS(th)}}$	V _{DS} = V _{GS} , I _D = 10mA	2.0	2.8	4.0	V	
Gate Threshold Voltage		V _{DS} = V _{GS} , I _D = 10mA, T _J = 175 °C		1.8		V	
	IDSS	V _{DS} = 1200V, V _{GS} = 0V		0.1	1.0	uA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 1200V, V _{GS} = 0V, T _J = 175 °C		1		uA	
Osta Osumaa kashama Oumant	I _{GSS+}	V _{GS} = 20V, V _{DS} = 0V		10	100	nA	
Gate Source Leakage Current	I _{GSS-}	V _{GS} = -5V, V _{DS} = 0V		-10	-100	nA	
Drain Source On-State	D	V _{GS} = 20V, I _D = 20A		77	100	mΩ	
Resistance	R _{DS(on)}	V _{GS} = 20V, I _D = 20A, T _J = 175 °C		137		mΩ	
Transconductors	rife	V _{DS} = 20 V, I _D = 20 A		10.5		s	
Transconductance	gfs	V _{DS} = 20 V, I _D = 20 A, T _J = 175 °C		8		S	
Input Capacitance	Ciss	$\begin{array}{c} C_{ISS} \\ C_{OSS} \end{array} V_{GS} = 0V, \\ V_{DS} = 1000V \end{array}$		1324			
Output Capacitance	Coss			74		pF	
Reverse Transfer Capacitance	C _{RSS}	V _{AC} = 25mV		3.4			
Coss Stored Energy	Eoss	f = 200kHz		37		uJ	
Turn-On Switching Energy	E _{ON}	V _{DS} = 800V, V _{GS} = -5/20V		290			
Turn-Off Switching Energy	EOFF	I_D = 20A, $R_{G(ext)}$ = 2.5 Ω		20		uJ	
Turn-On Delay Time	t _{d(on)}	V _{DS} = 800V, V _{GS} = -5/20V		20			
Rise Time	tr	I _D = 20A, R _{G(ext)} = 2.5Ω, L=975uH		11			
Turn-Off Delay Time	$t_{d(off)}$	FWD=S2M0080120K		20		ns	
Fall Time	t _f			7.8			
Internal Gate Resistance	R _{G(int)}	f = 1MHz, VAC = 25 mV, D-S short		3.3		Ω	
Gate to Source Charge	Q_{gs}	V _{DS} = 800V, V _{GS} = -5/20V		23			
Gate to Drain Charge	Q_{gd}	I _D = 20A		14		nC	
Total Gate Charge	Gate Charge Qg			54			



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Reverse Diode Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Diode Forward Voltage	V _{SD} V _{GS} = -5V, I _{SD} = 10A		4.0		V
	V _{SD}	V _{GS} = -5V, I _{SD} = 10A, T _J = 175°C	3.5		V
Continuous Diode Forward Current	ls	V _{GS} = -5V, T _C = 25℃		41	А
Reverse Recovery Time	t _{rr}	V _{GS} = -5V, I _{SD} = 20A, T _J = 25°C	25		ns
Reverse Recovery Charge	Qrr	V _R = 800V	102		nC
Peak Reverse Recovery Current	I _{mm}	dif/dt= 1950A/µs	6.7		А

Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T _{stg}	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	$R_{ ext{ heta}JC}$	DC operation	0.65	°C/W
Typical Thermal Resistance Junction to Ambient	R _{θJA}		32	°C/W

Ordering Information:

Device	Package	
S2M0080120K	TO-247-4	30pcs/tube

Marking Diagram



Where XXXXX is YYWWL

```
S2M
        = Device Type
```

0080 = R_{DS}(on) 120

= Reverse Voltage (1200V) = Package

SSG = SSG

Κ

L

- YΥ = Year ww
 - = Week
 - = Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

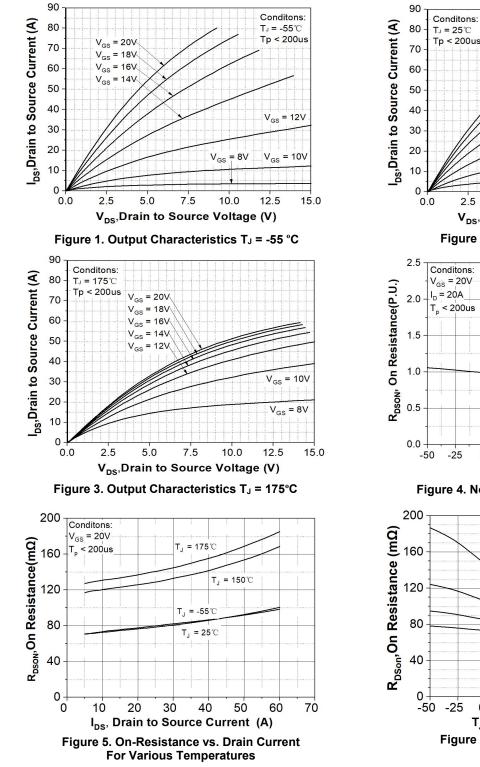
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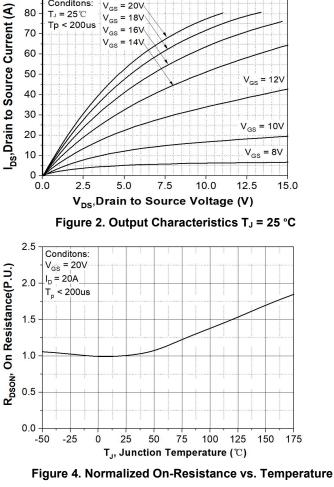


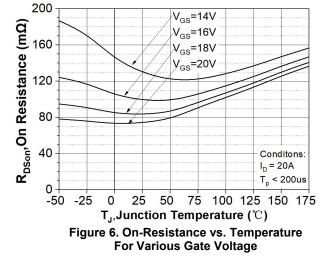
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Ratings and Characteristics Curves



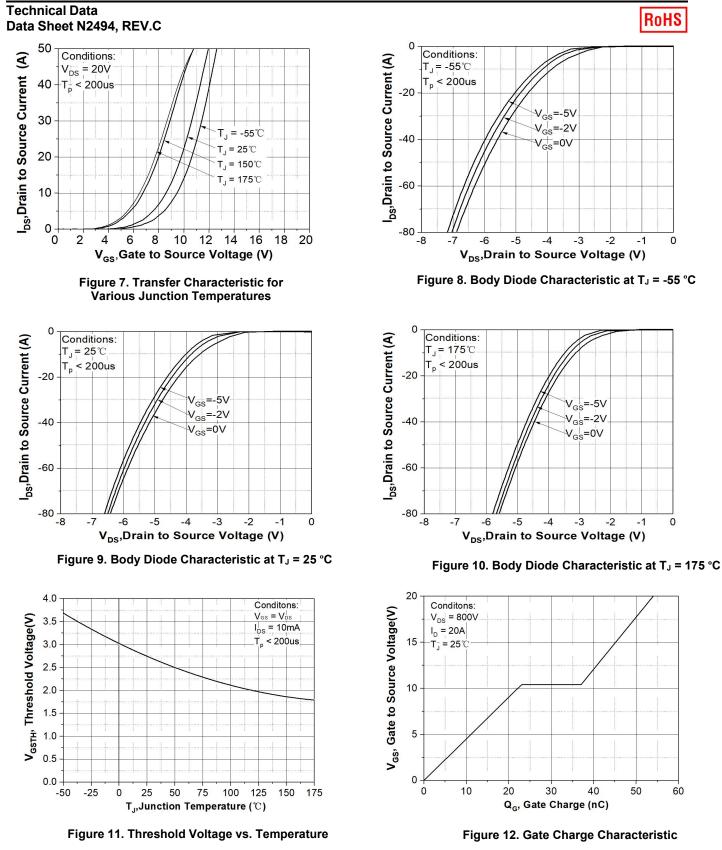




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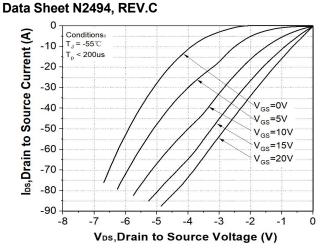


Figure 13. 3rd Quadrant Characteristic at T_J = -55 °C

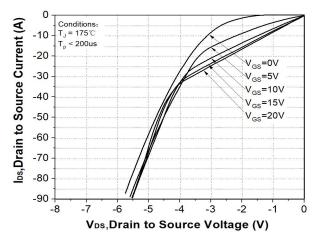
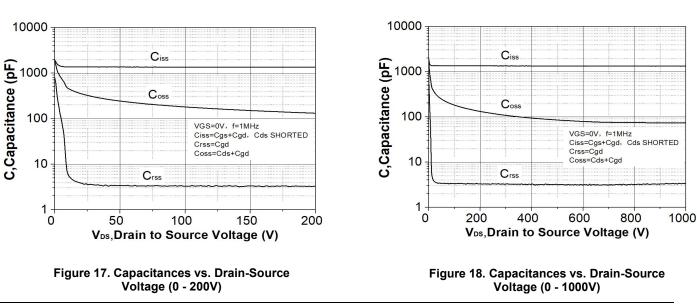


Figure 15. 3rd Quadrant Characteristic at T_J = 175°C



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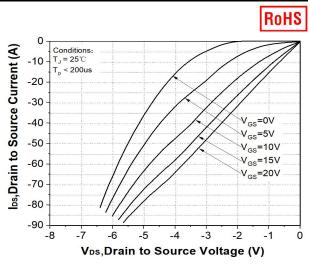


Figure 14. 3rd Quadrant Characteristic at T_J = 25 °C

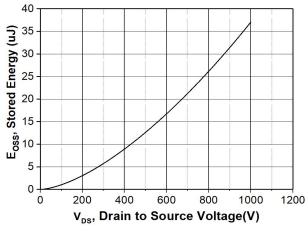
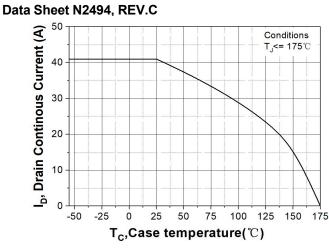


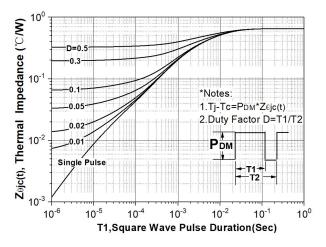
Figure 16. Output Capacitor Stored Energy

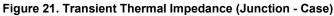
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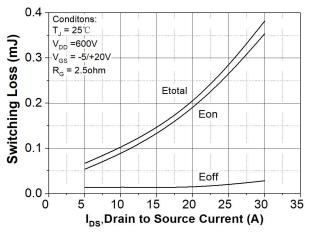


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 600V)

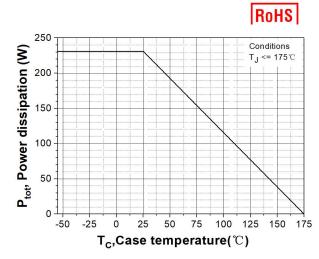


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

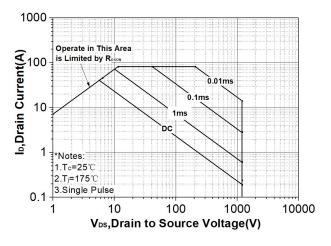
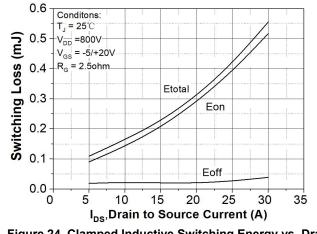
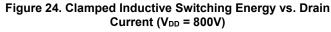
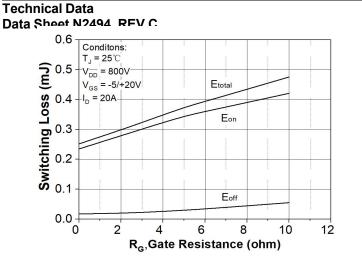


Figure 22. Safe Operating Area





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Figure 25. Clamped Inductive Switching Energy vs. R_{G(ext)}

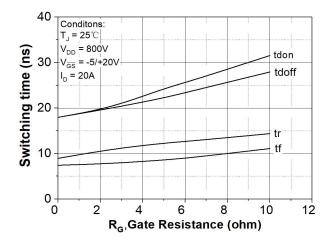


Figure 27. Switching Times vs. R_{G(ext)}

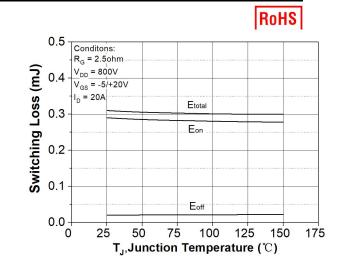


Figure 26. Clamped Inductive Switching Energy vs. Temperature

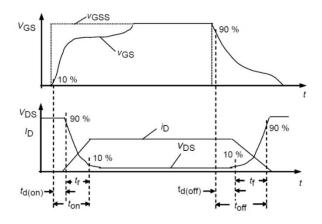


Figure 28. Switching Times Definition

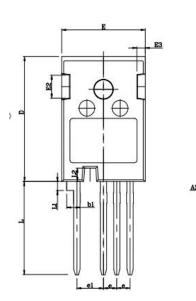
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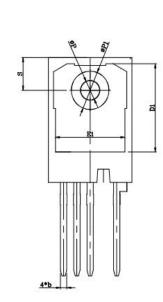


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Mechanical Dimensions TO-247-4





11 C

Symbol	In mm				
Symbol	Min	Nom	Max		
А	4.80	5.00	5.21		
A1	2.23	2.41	2.59		
A2	1.85	2.00	2.16		
b	1.07	1.20	1.36		
b1	2.35	2.67	2.94		
С	0.51	0.60	0.75		
D	23.30	23.45	23.60		
D1	16.25	16.55	17.65		
Е	15.75	15.94	16.13		
E1	13.00	14.02	14.15		
E2	3.68	4.40	5.10		
E3	1.00	1.45	1.90		
е	2.54 BSC				
e1	5.08 BSC				
L	17.31	17.57	17.82		
L1	1.50		4.37		
ΦP	3.51	3.61	3.65		
ΦP1	7.19 REF				
S	6.04	6.17	6.30		

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